2123 #16

Morney's Docket No. 004120.P005

PATENT

11-6-02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Re Patent Application of:

Jengsheng Jason Cong et al.

Application No.: 09/823,085

Filed: March 29, 2001

For: Method and Apparatus for

Calculation of Crosstalk Noise in

Integrated Circuits

Examiner: Unknown

Art Unit: 2123

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Technology Center 2100

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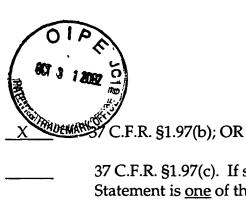
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Enclosed is a copy of Information Disclosure Citation Form PTO-1449 together with copies of the documents cited on that form. It is respectfully requested that the cited documents be considered and that the enclosed copy of Information Disclosure Citation Form PTO-1449 be initialed by the Examiner to indicate such consideration and a copy thereof returned to applicant(s).

Pursuant to 37 C.F.R. § 1.97, the submission of this Information Disclosure Statement is not to be construed as a representation that a search has been made and is not to be construed as an admission that the information cited in this statement is material to patentability.

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(2) A check for \$180.00 for the fee under 37 C.F.R. \$1.17(p) for submission of the Information Disclosure Statement.

If there are any additional charges, please charge Deposit Account No. 02-2666. Respectfully submitted,

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12400 Wilshire Blvd. Seventh Floor Los Angeles, CA 90025-1026 (408) 720-8300

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Substitute f r F rm 1449A/PTO (Modified)			d)	Complete if Known					
INFORMATION DISCLOSURE			OSLIBE	Application Number	09/823,085				
				Filing Date	March 29, 2001				
STATEMENT RY APPLICANT				First Named Inventor:	Jingsheng Jason Cong				
(use as many sheets as necessary)			sary)	Group Art Unit	2123				
OCT 3 1 2002 $\frac{C}{N^2}$				Examiner Name	UnknowLCEVED				
Sheet	4	of	1	Attorney Docket Number	004120.P005				
OTHER ART - NO PATENT LITERATURE DOCUMENTS									
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	A	KAWAGUCHI, H. et al.: "Delay and Noise Formulas for Capacitively Coupled Distributed RC lines", in Proc. Asia and South Pacific Design Automation Conf., pp. 35-43, 1998.							
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